JC' c'd PCT/PTO 2 6 MAR 2002

## **PATENT**

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re

: Application of Koeune

Concurrently herewith

For

: LOCKED BEAD CONSTRUCTION

Serial No.

Filed

Group Art Unit

Examiner

Our Docket No.

: DN1999200USA

March 26, 2002

# ASSISTANT COMMISSIONER OF PATENTS

Washington, D.C. 20231

# INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. 1.97

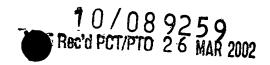
Sir:

The following information is disclosed in accordance with 37 C.F.R. 1.97.

The following patents, which are listed on the enclosed form PTO-1449 and submitted herewith in copy, are considered relevant prior art.

## **UNITED STATES**

Patent No.	<u>Patentee</u>	<u>Date</u>
5,779,829	Prakash et al.	07/14/98
5,742,976	Pena et al.	04/28/98
5,620,539	Ide	04/15/97
5,513,686	Diernaz	05/07/96
5,323,830	Diernaz	06/28/94
5,232,033	Durif	08/03/93
5,125,446	Durif	06/30/92
5,058,649	Hoang et al.	10/22/91
4,854,361	Gasowski et al.	05/08/90
4,700,765	Gasowski et al.	08/08/89
4,185,676	Raluy	01/29/80
4,139,040	Samoto et al.	02/13/79
3,784,426	Woodhall et al.	01/08/74



Patent No.	<u>Patentee</u>	<u>Date</u>
3,301,303	Travers	01/31/67
2,994,358	Trevaskis	06/20/61
1,188,062	Gammeter	06/20/16
1,147,032	McNaull	07/20/15

# FOREIGN PATENT DOCUMENTS

Document No.	Country	<u>Date</u>
0,953,435	EP	03/99
2,773,518	France	07/99
2,678,544	France	01/93
1,327,810	France	04/63
WO95/23073	PCT	02/95
1,000,113	United Kingdom	08/65

Due consideration and allowance of this application are respectfully solicited.

Respectfully submitted,

Howard M. Cohn

Registration No. 25,808

c/o Bruce Hendricks Dept. 823 The Goodyear Tire & Rubber Company 1144 East Market Street Akron, Ohio 44309-3531 (216) 752-0955 phone

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#### INFORMATION DISCLOSURE C ION (Use several sheets if necessary

ATTY DOCKET NO. DN1999200USA

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### **U.S. PATENT DOCUMENTS**

'EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE  IF APPROPRIATE
	5,779,829	07/14/98	Prakash et al.			
	5,743,976	04/28/98	Pena et al.			
	5,620,539	04/15/97	Ide			
	5,513,686	05/07/96	Diernaz			
	5,323,830	06/28/94	Diernaz			
	5,232,033	08/03/93	Durif			
	5,125,446	06/30/92	Durif			
	5,058,649	10/22/91	Hoang et al.	E TW		
	4,922,985	05/08/90	Gasowski et al.			
	4,854,361	08/08/89	Gasowski et al.			
	4,700,765	10/20/87	Masclaux			

## **FOREIGN PATENT DOCUMENTS**

DOCUMENT NUMBER	DATE COUNTRY	CLASS	SUBCLASS	TRANSLATION		
BOCOMENT NOMBER	DATE	COUNTRY	CLASS	300022333	YES	NO
0,953,435	03/99	EP				1
2,773,518	07/99	France				1
2,678,544	01/93	France				1
1,327,810	04/63	France		-		J
WO95/23073	02/95	PCT				1

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

**DATE CONSIDERED EXAMINER** 

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE  IF APPROPRIATE
	4,185,676	01/29/80	Raluy			
	4,139,040	02/13/79	Samoto et al.			
	3,784,426	01/08/74	Woodhall et al.			
-	3,301,303	01/31/67	Travers			
	2,994,358	08/01/61	Trevaskis			
	1,188,062	06/20/16	Gammeter			
	1,147,032	07/20/15	McNaull			
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### **FOREIGN PATENT DOCUMENTS**

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